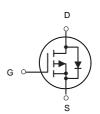


Description

The SI7635DP-T1-GE3 uses advanced trench technology to provide excellent R_{DS(ON)}, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



DFN5X6-8L



P-Channel MOSFET

General Features

 $V_{DS} = -18V I_{D} = -80A$

 $R_{DS(ON)}$ <3 m Ω V_{GS}=-10V

Application

Battery protection

Load switch

Uninterruptible power supply

Package Marking and Ordering Information

Product ID	Pack	Brand	Qty(PCS)
SI7635DP-T1-GE3	DFN5X6-8L	HXY MOSFET	5000

Absolute Maximum Ratings (Tc=25[°]Cunless otherwise noted)

Vps Vgs	Drain-Source Voltage	-18	V
VGS	0 1 0 1/1		V
	Gate-Source Voltage	±12	V
I _D @T _C =25°C	Continuous Drain Current, V _{GS} @ 10V ¹ -80		А
Ірм	Pulsed Drain Current ² -360		А
P _D @T _C =25°C	Total Power Dissipation ⁴	41.67	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	TJ Operating Junction Temperature Range -55 to 150		°C
Reja	Thermal Resistance Junction-Ambient ¹	esistance Junction-Ambient ¹ 62	
R _θ Jc Thermal Resistance Junction-Case ¹		3	°C/W



Electrical Characteristics (T_J=25 °C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit	
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =-250uA	-18			V	
$\triangle BV_{DSS}/\triangle T_{J}$	BV _{DSS} Temperature Coefficient	ficient Reference to 25°C , I _D =-1mA		-0.008		V/°C	
I _{DSS}	Drain-Source Leakage Current	V _{DS} =-20V , V _{GS} =0V , T _J =25°C			-1	uA	
	Diam-Source Leakage Current	V _{DS} =-16V , V _{GS} =0V , T _J =125°C			-30	uA	
Igss	Gate-Source Leakage Current	V _{GS} =±12V , V _{DS} =0V			±500	nA	
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} =-4.5V , I _D =-20A		2.5	3.0	mΩ	
		V _{GS} =-2.5V , I _D =-20A		3.3	4.5		
$V_{\text{GS(th)}}$	Gate Threshold Voltage	V _{GS} =V _{DS} , I _D =-250uA	-0.4	-0.6	-1.0	V	
$ riangle V_{GS}$	V _{GS(th)} Temperature Coefficient	VGS-VDS , ID250UA		-3.44		mV/°C	
gfs	Forward Transconductance	V _{DS} =-10V , I _S =-3A		30		S	
Q_g	Total Gate Charge ^{2,3}			149	225		
Q_gs	Gate-Source Charge ^{2,3}	V _{DS} =-16V , V _{GS} =-4.5V , I _D =-5A		14.4	22	nC	
Q_{gd}	Gate-Drain Charge ^{2, 3}			42.8	65		
$T_{d(on)}$	Turn-On Delay Time ^{2,3}			21.2	42		
Tr	Rise Time ^{2, 3}	V_{DD} =-15V , V_{GS} =-4.5V , R_{G} =25 Ω		20.6	40	nS	
$T_{d(off)}$	Turn-Off Delay Time ^{2,3}	I _D =-1A		26	52		
Tf	Fall Time ^{2, 3}			400	600		
Ciss	Input Capacitance			12000	16000		
Coss	Output Capacitance	V_{DS} =-15V , V_{GS} =0V , F=1MHz		1670	2500	pF	
C _{rss}	Reverse Transfer Capacitance			730	1100		
Rg	Gate resistance	V _{GS} =0V, V _{DS} =0V, F=1MHz		2.6		Ω	
Is	Continuous Source Current	\\ =\\ =0\\ Fores Current			-85	Α	
I _{SM}	Pulsed Source Current	V _G =V _D =0V , Force Current			-190	Α	
V _{SD}	Diode Forward Voltage	V _{GS} =0V , I _S =-1A , T _J =25°C			-1	V	

Note:

- 1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
- 2. The data tested by pulsed , pulse width ≤ 300 us , duty cycle $\leq 2\%$.
- Essentially independent of operating temperature.

Typical Performance Characteristics

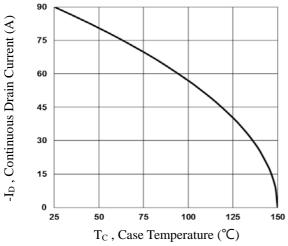


Fig.1 Continuous Drain Current vs. Tc

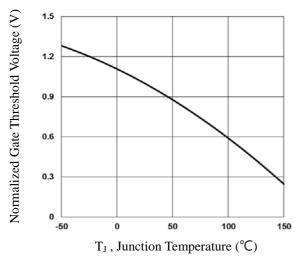


Fig.3 Normalized V_{th} vs. T_J

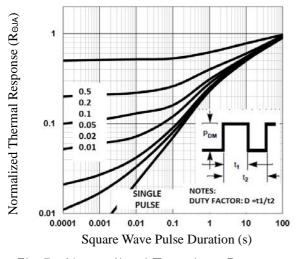


Fig.5 Normalized Transient Response

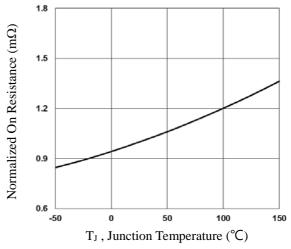


Fig. 2 Normalized RDSON vs. TJ

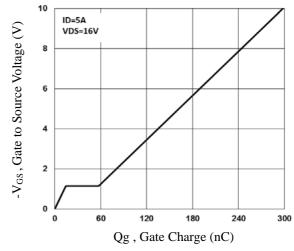


Fig.4 Gate Charge Waveform

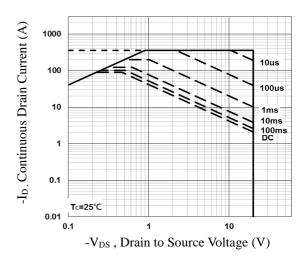
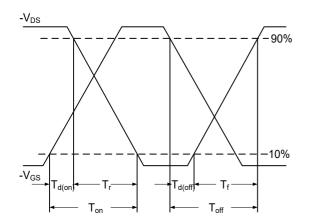
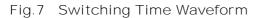


Fig.6 Maximum Safe Operation Area





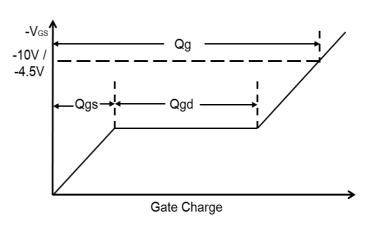
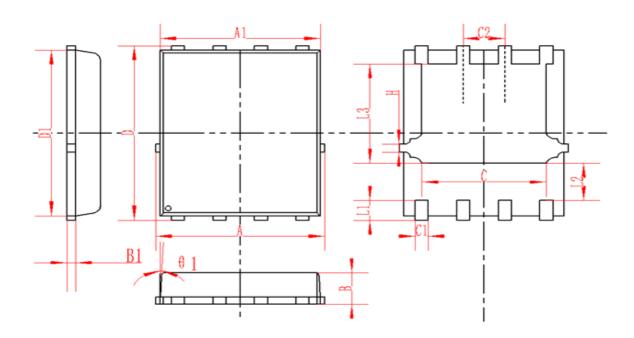


Fig.8 Gate Charge Waveform

DFN5X6-8L Package Information



SYMBOL	MM		INCH			
STIVIDOL	MIN	NOM	MAX	MIN	NOM	MAX
А	4.95	5	5.05	0.195	0.197	0.199
A1	4.82	4.9	4.98	0.190	0.193	0.196
D	5.98	6	6.02	0.235	0.236	0.237
D1	5.67	5.75	5.83	0.223	0.226	0.230
В	0.9	0.95	1	0.035	0.037	0.039
B1	0.254REF		0.010REF			
С	3.95	4	4.05	0.156	0.157	0.159
C1	0.35	0.4	0.45	0.014	0.016	0.018
C2		1.27TYP			0.5TYP	
θ1	8°	10°	12°	8°	10°	12°
L1	0.63	0.64	0.65	0.025	0.025	0.026
L2	1.2	1.3	1.4	0.047	0.051	0.055
L3	3.415	3.42	3.425	0.134	0.135	0.135
Н	0.24	0.25	0.26	0.009	0.010	0.010



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